

## SiC SBD P3D06002E2

### 650V SiC Schottky Diode



#### Features

- Qualified to AEC-Q101
- Ultra-Fast Switching
- Zero Reverse Recovery Current
- High-Frequency Operation
- Positive Temperature Coefficient on  $V_F$
- High Surge Current
- 100% UIS Tested

TO-252-2

Cathode	1
Anode	2



#### Standards Benefits

- Improve System Efficiency
- Reduction of Heat Sink Requirement
- Essentially No Switching Losses
- Parallel Devices Without Thermal Runaway



#### Application

- Consumer SMPS
- Boost Diodes in PFC or DC/DC Stages
- AC/DC Converters



#### Order Information

Part Number	Package	Marking
P3D06002E2	TO-252-2	P3D06002E2



## Contents

Features.....	1
Standards Benefits .....	1
Application.....	1
Order Information .....	1
<b>Contents.....</b>	<b>2</b>
1. Maximum Ratings.....	3
2. Electrical Characteristics.....	4
3. Thermal Characteristics .....	4
4. Typical Performance .....	5
5. Package Outlines .....	6

PNJ Preliminary

## 1. Maximum Ratings

At  $T_J = 25^\circ\text{C}$ , unless specified otherwise

Parameter	Symbol	Value	Unit	Test condition
Repetitive Peak Reverse Voltage	$V_{RRM}$	650	V	$T_C = 25^\circ\text{C}$
Surge Peak Reverse Voltage	$V_{RSM}$	650	V	$T_C = 25^\circ\text{C}$
DC Blocking Voltage	$V_R$	650	V	$T_C = 25^\circ\text{C}$
Forward Current	$I_F$	9 5 2	A	$T_C = 25^\circ\text{C}$ $T_C = 125^\circ\text{C}$ $T_C = 164^\circ\text{C}$
Non-Repetitive Forward Surge Current	$I_{FSM}$	18 15	A	$T_C = 25^\circ\text{C}, t_p = 10\text{ms}$ $T_C = 125^\circ\text{C}, t_p = 10\text{ms}$
Repetitive Peak Forward Surge Current	$I_{FRM}$	10 4	A	$T_C = 25^\circ\text{C}, t_p = 10\text{ms}$ $T_C = 125^\circ\text{C}, t_p = 10\text{ms}$
Power Dissipation	$P_{tot}$	43	W	$T_C = 25^\circ\text{C}$
Operating Junction and Storage Temperature	$T_J, T_{STG}$	-55 to +175	$^\circ\text{C}$	

## 2. Electrical Characteristics

At  $T_J = 25^\circ\text{C}$ , unless specified otherwise

Parameter	Symbol	Values			Unit	Test condition
		Min.	Typ.	Max.		
Forward Voltage	$V_F$	/	1.5	1.7	V	$I_F = 2\text{A}, T_J = 25^\circ\text{C}$
			1.8	/		$I_F = 2\text{A}, T_J = 175^\circ\text{C}$
Reverse Current	$I_R$	/	1.5	10	$\mu\text{A}$	$V_R = 650\text{V}, T_J = 25^\circ\text{C}$
			64.4	/		$V_R = 650\text{V}, T_J = 175^\circ\text{C}$
Total Capacitance	C	/	92.4	/	pF	$V_R = 0\text{V}, T_J = 25^\circ\text{C}$ $f = 1\text{MHz}$
			9			$V_R = 200\text{V}, T_J = 25^\circ\text{C}$ $f = 1\text{MHz}$
			6.6			$V_R = 400\text{V}, T_J = 25^\circ\text{C}$ $f = 1\text{MHz}$
Total Capacitive Charge	$Q_C$	/	4.72	/	nC	$V_R = 400\text{V}, I_F = 2\text{A}$ $di/dt = 500\text{A}/\mu\text{s}$ $T_J = 25^\circ\text{C}$

## 3. Thermal Characteristics

Parameter	Symbol	Values	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	3.5	$^\circ\text{C}/\text{W}$

## 4. Typical Performance

At  $T_J = 25^\circ\text{C}$ , unless specified otherwise

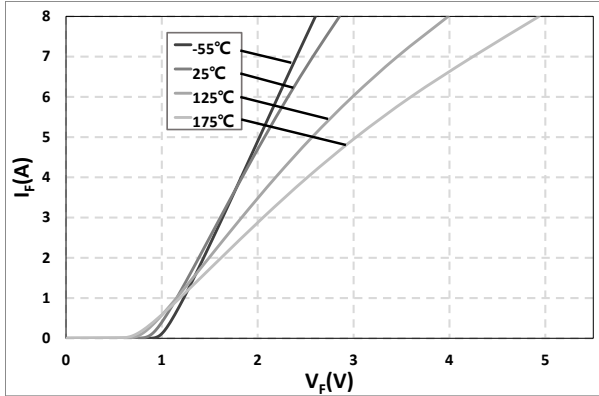


Fig. 1 Typical Forward Characteristics  
 $I_F = f(V_F)$ ;  $T_J = -55^\circ\text{C}, 25^\circ\text{C}, 125^\circ\text{C}, 175^\circ\text{C}$

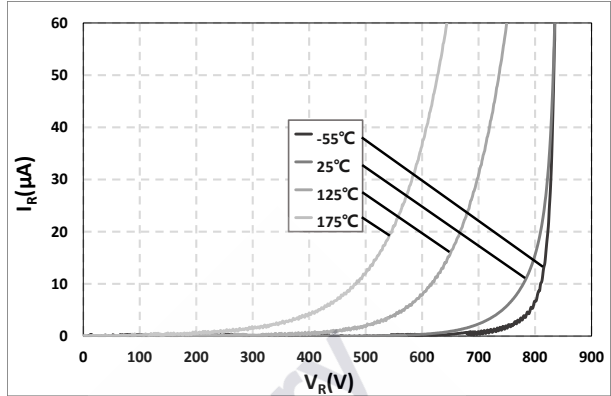


Fig. 2 Reverse Characteristics  
 $I_R = f(V_R)$ ;  $T_J = -55^\circ\text{C}, 25^\circ\text{C}, 125^\circ\text{C}, 175^\circ\text{C}$

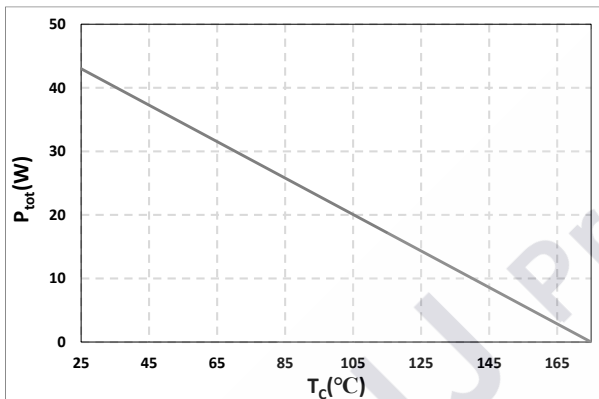


Fig. 3 Typical Power Derating  
 $P_{tot} = f(T_c)$

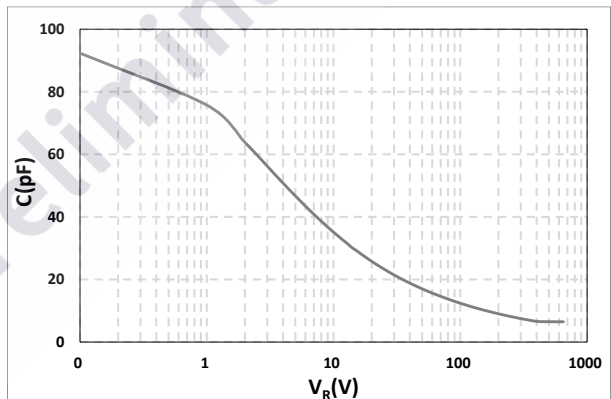


Fig. 4 Typical Total Capacitance  
 $C = f(V_R)$

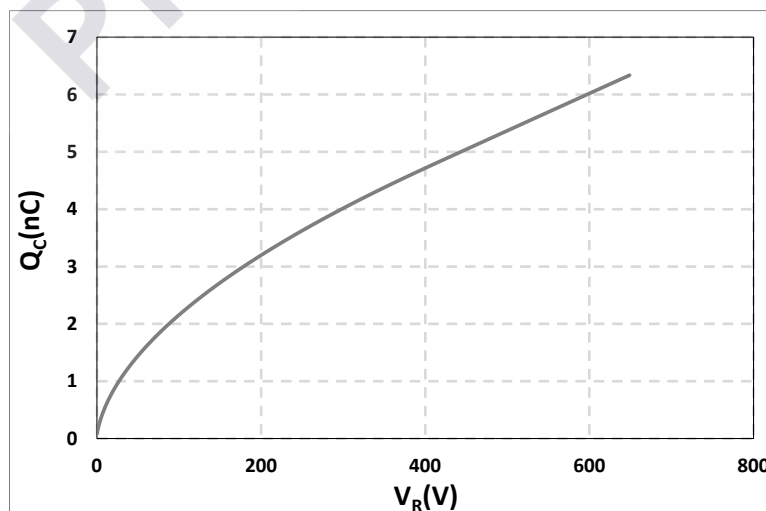
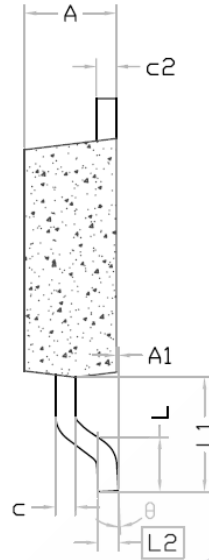
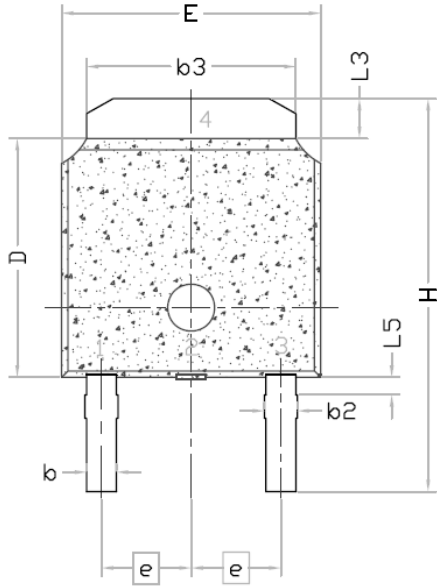


Fig. 5 Typical Total Capacitive Charge  
 $Q_c = f(V_R)$

### 5. Package Outlines



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
E	6.40	6.60	6.731
L	1.40	1.52	1.77
L1	2.743 REF		
L2	0.508 BSC		
L3	0.89	--	1.27
L5	--	--	--
D	6.00	6.10	6.223
H	9.40	10.00	10.40
b	0.64	0.76	0.88
b2	0.77	0.84	1.14
b3	5.21	5.34	5.46
e	2.286 BSC		
A	2.20	2.30	2.38
A1	0	--	0.127
c	0.46	0.50	0.60
c2	0.46	0.50	0.58
D1	5.21	--	--
E1	4.40	--	--
F	--	--	0.45
theta	0°	--	10°

Drawing and dimensions

PNJ Preliminary